TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOSⅢ)

# SSM4K27CT

## Switching Applications

Small package

Low on-resistance:  $R_{DS(ON)} = 205 \text{ m}\Omega \text{ (max) (@V_{GS} = 4.0 V)}$ 

 $R_{DS(ON)} = 260 \text{ m}\Omega \text{ (max) (@V_{GS} = 2.5 V)}$ 

 $RDS(ON) = 390 \text{ m}\Omega \text{ (max) (@VGS} = 1.8 \text{ V)}$ 

## **Absolute Maximum Ratings (Ta = 25°C)**

Characteristics		Symbol	Rating	Unit	
Drain-Source voltage		$V_{DSS}$	20	\ \ \ \	
Gate-Source voltage		$V_{GSS}$	±12	$(\nearrow)$	
Drain current	DC	ΙD	0.5	A	
	Pulse	I <sub>DP</sub>	1.0		
Power dissipation		P <sub>D</sub> (Note 1)	400	mW	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Unit: mm Side view CST4 JEDEC JEITA **TOSHIBA** 2-1M1A

Weight: 1.1 mg (typ.)

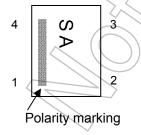
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

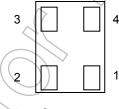
Note 1: Mounted on FR4 board.

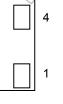
 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}, \text{ Cu Pad: } 645 \text{ mm}^2)$ 

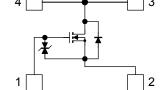
## Marking (top view)

#### Electrode Layout (bottom view) Equivalent Circuit (top view)









- Gate
- 2 Source
- 3 Drain
- Drain

# **Handling Precaution**

When handling individual devices (which are not yet mounted on a circuit board), ensure that the environment is protected against static electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

> Start of commercial production 2005-02

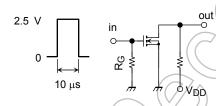
# Electrical Characteristics (Ta=25°C)

Chara	cteristics	eristics Symbol Test Condition		Min.	Тур.	Max.	Unit
Gate leakage current		I <sub>GSS</sub>	$V_{GS} = \pm 12 \text{ V}, V_{DS} = 0$	=	_	±1	μΑ
Drain-Source breakdown voltage		V (BR) DSS	$I_D = 1 \text{ mA}, V_{GS} = 0$	20	_	_	V
		V (BR) DSX	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = -12 V	10	-	_	
Drain cut-off curre	ent	I <sub>DSS</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0			10	μΑ
Gate threshold vo	Itage	V <sub>th</sub>	V <sub>DS</sub> = 3 V, I <sub>D</sub> = 1 mA	0.5	) }^_	1.1	V
Forward transfer a	admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 3 V, I <sub>D</sub> = 0.25 A (Note2)	0.8	1.6	-	S
Drain-Source on-resistance		R <sub>DS</sub> (ON)	I <sub>D</sub> = 0.25 A, V <sub>GS</sub> = 4 V (Note2)	$\bigcirc$	175	205	mΩ
			I <sub>D</sub> = 0.25 A, V <sub>GS</sub> = 2.5 V (Note2)		200	260	
			I <sub>D</sub> = 0.10 A, V <sub>GS</sub> = 1.8 V (Note2)	<sup>7</sup> —	250	390	
Input capacitance		C <sub>iss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0, f = 1 MHz	-	174	-	pF
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0, f = 1 MHz	-	25	<b>/</b>	pF
Output capacitance		Coss	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0, f = 1 MHz	-6	31	> -	pF
Switching time	Turn-on time	t <sub>on</sub>	V <sub>DD</sub> = 10 V, I <sub>D</sub> = 0.25 A,	7-6	10	) -	ns
	Turn-off time	t <sub>off</sub>	$V_{GS} = 0$ to 2.5 V, $R_G = 4.7 \Omega$		12	_	



#### **Switching Time Test Circuit**

(a) Test Circuit



 $V_{DD} = 10 \text{ V}$ 

 $R_G = 4.7 \Omega$ 

Duty ≤ 1%

 $V_{IN}$ :  $t_r$ ,  $t_f < 5$  ns

Common Source

Ta = 25°C

#### **Precaution**

 $V_{th} \ can be expressed as the voltage between the gate and source when the low operating current value is ID = 1 mA for this product. For normal switching operation, VGS (on) requires a higher voltage than Vth and VGS (off) requires a lower voltage than Vth. (The relationship can be established as follows: VGS (off) < Vth < VGS (on).)$ 

(b) V<sub>IN</sub>

(c) Vout

2,5 V

 $V_{DD}$ 

VDS (ON)

90%

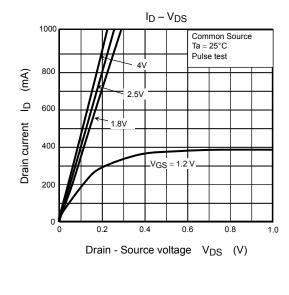
10%

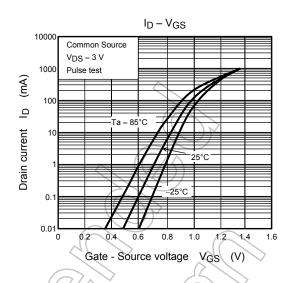
90%

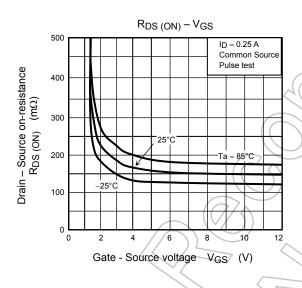
10%

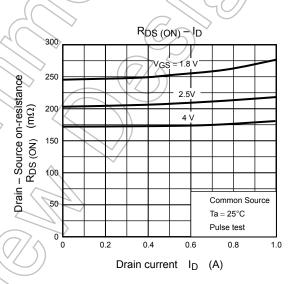
Be sure to take this into consideration when using the device.

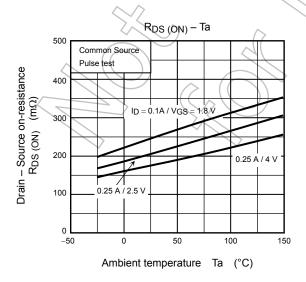
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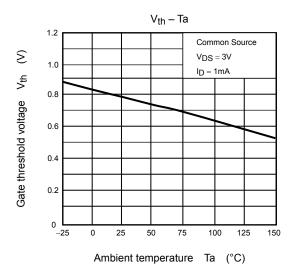






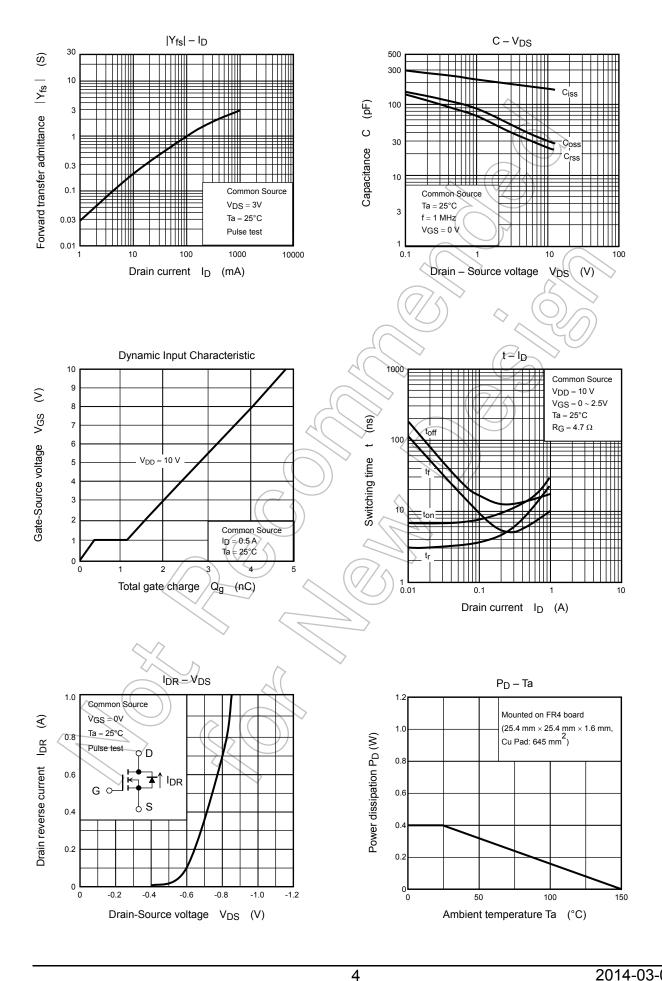






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